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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent application of:

Mark PAVIER et al.

Date: December 29, 2003

Serial No.: 10/045,809

Group Art Unit: 2814

Filed: January 11, 2002

Examiner: P. Cao

Notice of Allowance: November 12, 2003

Confirmation No.: 2069

For: CLIP-TYPE LEAD FRAME FOR SOURCE MOUNTED DIE

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Attn: Official Draftsperson

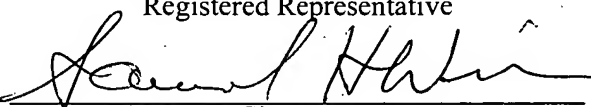
SUBMISSION OF FORMAL DRAWINGS

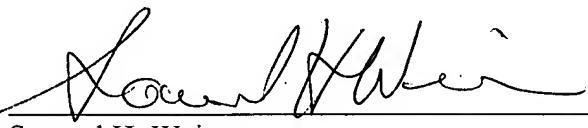
Sir:

Responsive to the Notice of Allowance dated November 12, 2003, enclosed herewith please find three (3) sheets of formal drawings containing Figures 1 through 6 for the above-identified application.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, Washington, D.C. 20231, on December 29, 2003:

Respectfully submitted,

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